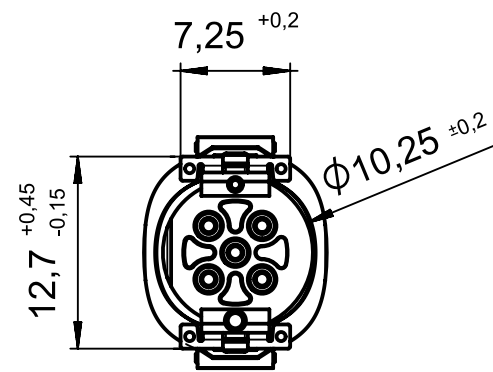
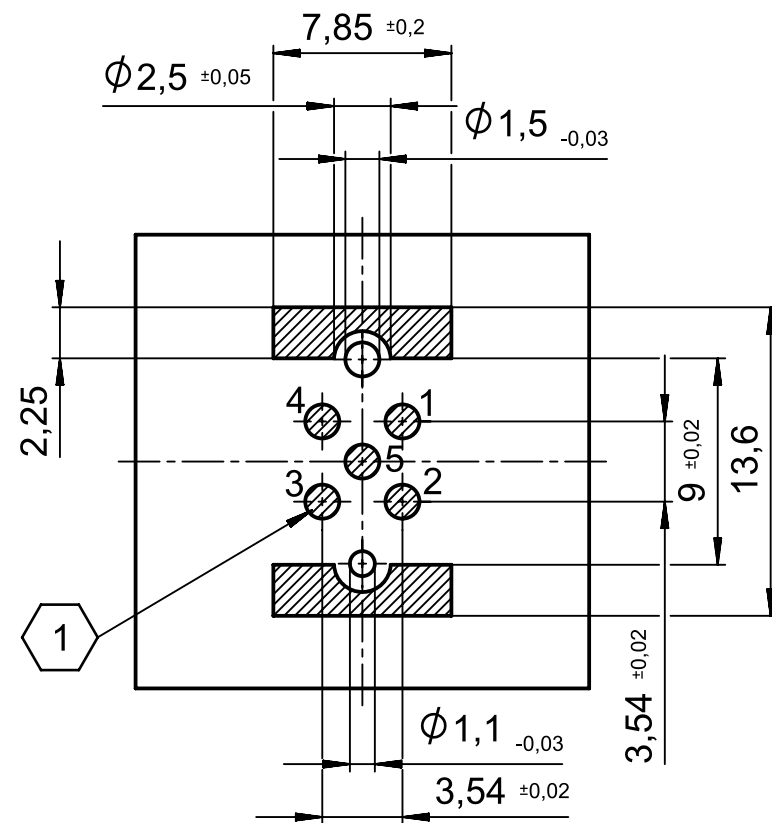


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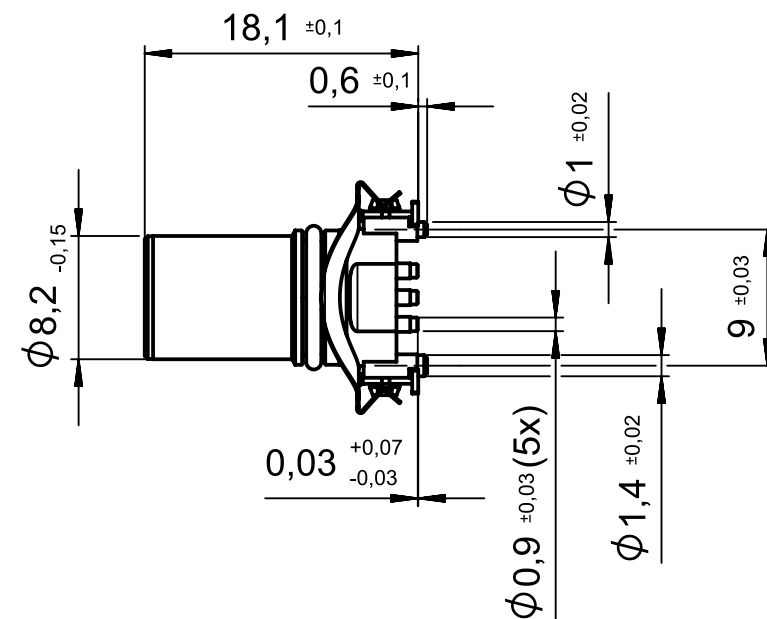
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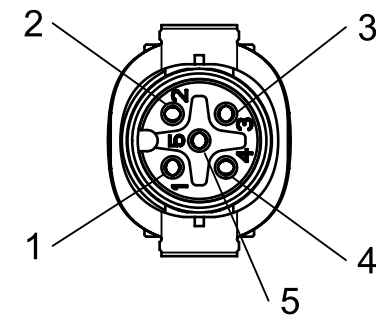
PCB-layout
(advice)



3:1



socket face female



Coplanarity of all contacts and anchor plate  0.1

Recommended solder paste thickness 150µm

 Further information on soldering process and recommended layout, see brochure "Connectors for SMT production"

 DIN A3			document-no. / ri 102948943 / 01	article-no. / ri 1412006 / 07	scale 2:1	- Simplified representation - Linear dimensions (mm)
			date 2025-10-24	document-type TECDOC 2D-Productdrawing		
page 1 of 1			description SACC-CIP-M12FS-5P SMD SH R32			

- EN ISO 291 23/50

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